



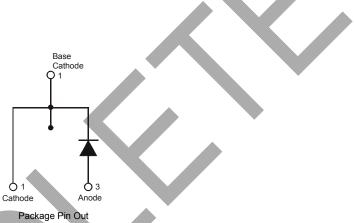
#### **8A DIODESTAR RECTIFIER**

### **Features**

- DIODESTAR<sup>™</sup> is a Proprietary Process for High Voltage Rectifiers which Delivers:
  - Ultra-Fast Reverse Recovery (trr < 30ns) Giving a Rapid Switching Response
  - Soft Recovery for Low EMI Noise
  - **Excellent High Temperature Stability**
  - High Forward Surge Capability
- Enables High Efficiency as the Boost Diode in PFC Circuits
- Lead Free Finish, RoHS Compliant (Note 1)

#### **Mechanical Data**

- Case: TO220AC
- Case Material: Molded Plastic, UL Flammability Classification Rating 94V-0
- Terminals: Matte Tin Finish annealed over Copper leadframe. Solderable per MIL-STD-202, Method 208 @3



Configuration

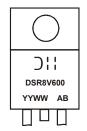
# Ordering Information (Note 2)

Part Number	Case	Packaging
DSR8V600	TO220AC	50 pieces/tube
DSR8V600-G	TO-220AC	50 pieces/tube

1. EU Directive 2002/95/EC (RoHS). All applicable RoHS exemptions applied, see EU Directive 2002/95/EC Annex Notes. Notes:

2. For packaging details, go to our website at http://www.diodes.com.
3.For Green Molding compound version part numbers.add"G" suffix to part number above Examples:DSR8V600-G.

## **Marking Information**



DSR8V600 = Product Type Marking Code AB = Foundry and Assembly Code YYWW = Date Code Marking YY = Last two digits of year (ex: 10 = 2010) WW = Week (01 - 53)





## Maximum Ratings @TA = 25°C unless otherwise specified

Single phase, half wave, 60Hz, resistive or inductive load.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>RM</sub>	600	V
Average Rectified Output Current	lo	8	Α
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I <sub>FSM</sub>	65	А

## **Thermal Characteristics**

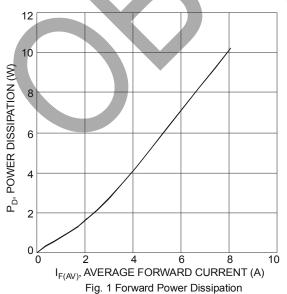
Characteristic	Symbol	Value	Unit
Typical Thermal Resistance (Note 3)	$R_{ heta JC}$	2	°C/W
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-65 to +175	°C

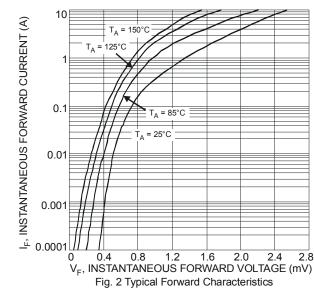
# Electrical Characteristics @TA = 25°C unless otherwise specified

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
Forward Voltage Drop	V <sub>F</sub>	-	-	3.2	V	I <sub>F</sub> = 8A, T <sub>J</sub> = 25°C	
Toward Voltage Drop	VF	-	1.7	2.8	•	I <sub>F</sub> = 8A, T <sub>J</sub> = 125°C	
Leakage Current (Note 4)	1_		1	20	μΑ	V <sub>R</sub> = 600V, T <sub>J</sub> = 25°C	
Leakage Current (Note 4)	IR	1	66.5	300		V <sub>R</sub> = 600V, T <sub>J</sub> = 125°C	
		7	18 23		$I_F = 1A$ , $V_R = 30V$ ,		
Reverse Recovery Time				23	ns	di/dt = 100A/μs	
Reverse Recovery Time	t <sub>rr</sub>		11.5	11.5 20		$I_F = 1A$ , $V_R = 30V$ ,	
			11.5	20		di/dt = 200A/μs	
Softness Factor	S		1.0	-	1	- 1 - 00 41/44 - 500/ 5	
Reverse Recovery Current	$I_{RM}$	-	1.0	-	Α	I <sub>F</sub> = 8A, dl/dt = 50A/μs, V <sub>R</sub> = 400V, T <sub>J</sub> = 25°C	
Reverse Recovery Charges	$Q_{rr}$	-	34	-	nC	$\frac{1}{1}$ $\sqrt{1}$ $\frac{1}{1}$ $\frac{1}$ $\frac{1}{1}$ $\frac{1}{1}$ $\frac{1}{1}$ $\frac{1}{1}$ $\frac{1}{1}$ $\frac{1}{1}$	
Softness Factor	S	-	0.6	-	-	1 - 00 dl/dt - 500/ c	
Reverse Recovery Current	I <sub>RM</sub>		2.0	-	$A_{\rm F} = 8A,  \text{di/dt} = 50A/\mu \text{s},  \text{V}_{\rm R} = 400V,  \text{T}_{\perp} = 125^{\circ}\text{C}$	I <sub>F</sub> = 8A, dl/dt = 50A/μs,	
Reverse Recovery Charges	Q <sub>rr</sub>	1	114	-	nC	V <sub>R</sub> - 400 V, 1j - 125 C	
Junction Capacitance (Note 5)	CJ	-	55	-	pF	4.0V, 1MHz	

Notes:

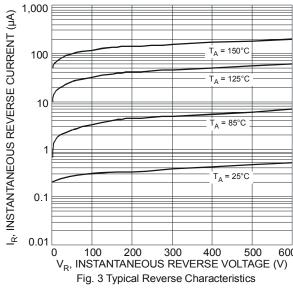
- 3. Test with additional heatsink, (Black Aluminum, 45mm\*20mm\*12mm) 4. Short duration pulse test used to minimize self-heating effect.
- 5. To evaluate the maximum conduction losses use the following equation:  $P = 1.2 \text{ x } I_{F(AV)} + 0.087 \text{ IF2 (RMS)}$

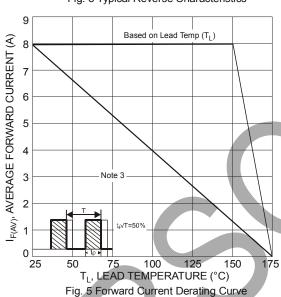


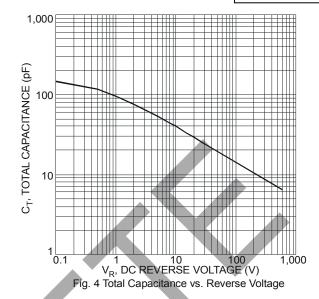


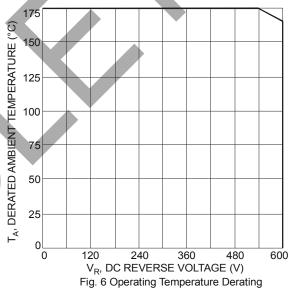




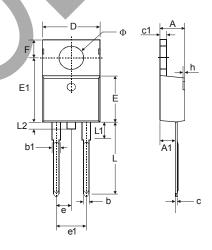








# **Package Outline Dimensions**



10220AC			
Dim	Min	Max	
Α	4.47	4.67	
A1	2.52	2.82	
b	0.71	0.91	
b1	1.17	1.37	
С	0.31	0.53	
c1	1.17	1.37	
D	10.01	10.31	
Е	8.50	8.90	
E1	12.06	12.46	
е	2.54 Typ		
e1	4.98	5.18	
F	2.59	2.89	
h	0.00	0.30	
L	13.40	13.80	
L1	3.56	3.96	
L2	-	1.00	
Φ	3.735	3.935	
All Dimensions in mm			

TOSSOAC





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